

## **Product Change Notification**

Change Notification #: 116820 - 00

Change Title: Select Intel Atom® x5-E3930,

x5-E3940 and x7-E3950 Processors, PCN 116820-00, Manufacturing Site, Adding Vietnam as additional qualified

Mfg Site

Date of Publication: March 08, 2019

#### **Key Characteristics of the Change:**

Manufacturing Site

#### **Forecasted Key Milestones:**

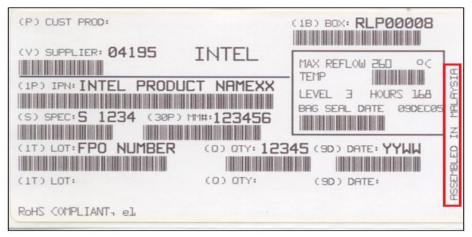
Date Customer Must be Ready to Receive Post-Conversion Material:	April 6, 2019	
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#### **Description of Change to the Customer:**

In order to ensure a continuous supply of the Select Intel Atom® x5-E3930, x5-E3940 and x7-E3950 Processors listed in the "Products Affected" Table below, Vietnam will become a second Manufacturing site for the Assembly, Test and Finish of products.

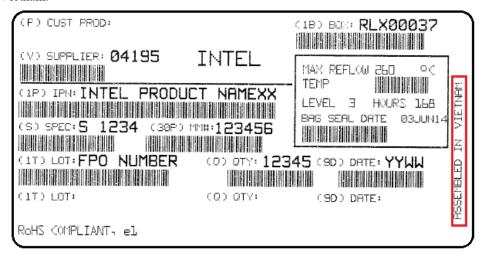
Customers take note that Vietnam will become a new fully certified manufacturing site and therefore, full flow manufacturing [Assembly, Test and Finish] could be done in either Malaysia or Vietnam. Vietnam has been certified equivalent (form, fit, function, and reliability) for the affected products and technologies of this change.

If Malaysia is the Country of Origin (COO) where Assembly was performed, the box label will display MALAY.



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If Vietnam is the Country of Origin (COO) where Assembly was performed, the box label will display Vietnam.



#### **Customer Impact of Change and Recommended Action:**

The label value for the Country Code as shown above will depend on where Assembly is performed. If products are assembled in Vietnam, the Vietnam Country Code will print. Likewise, if products are assembled in Malaysia, they would see the Malaysia Country Code value.

Customers may contact their Intel Field Sales Representative or the contacts listed on the last page of this Product Change Notification appropriate to your geo with questions.

#### **Products Affected / Intel Ordering Codes:**

Marketing Name	Processor#	Platform	<b>Product Code</b>	S-Spec	MM#
Intel Atom®	E3930	EMBEDDED	LH8066803102701	S R33Q	953086
Intel Atom®	E3940	EMBEDDED	LH8066803102401	S R33M	953083
Intel Atom®	E3950	EMBEDDED	LH8066803102601	S R33P	953085

### **PCN Revision History:**

Date of Revision: Revision Number: Reason:

March 8, 2019 00 Originally Published PCN

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Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

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